SDLS131 - APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

## description

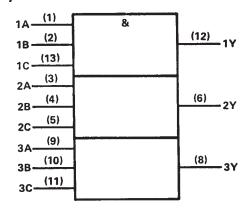
These devices contain three independent 3-input AND gates.

The SN54LS11 and SN54S11 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125 °C. The SN74LS11 and SN74S11 are characterized for operation from 0 °C to 70 °C.

## **FUNCTION TABLE (each gate)**

II	VPUT	s	OUTPUT
Α	В	С	Y
Н	Н	н	Н
L	X	X	L
×	L	x	L
х	X	L	L

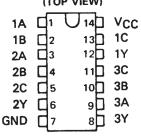
## logic symbol†



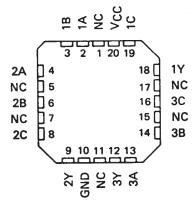
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54LS11, SN74S11 . . . J OR W PACKAGE SN74LS11, SN74S11 . . . D OR N PACKAGE (TOP VIEW)

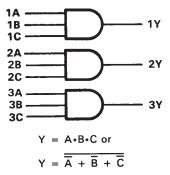


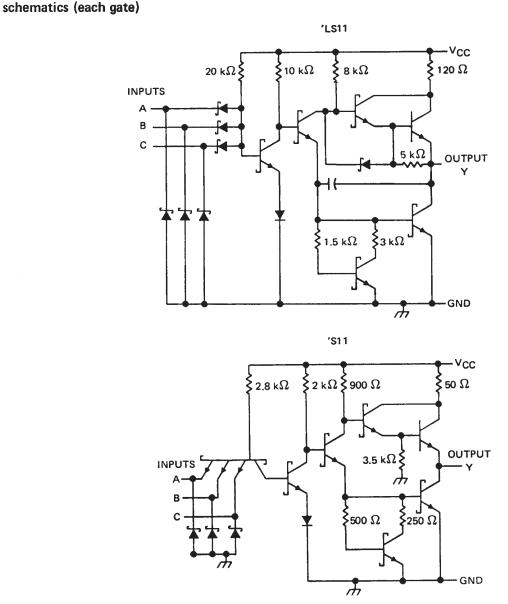
SN54LS11, SN54S11 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

## logic diagram (positive logic)





Resistor values shown are nominal.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage: 'S11	5.5 V
	7 V
Operating free-air temperature range	SN54'
	SN74' 0°C to 70°C
Storage temperature range	65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



#### recommended operating conditions

			SN54LS11			SN74LS11			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.7			0.8	٧	
ЮН	High-level output current			- 0.4			- 0.4	mA	
loL	Low-level output current			4			8	mA	
TA	Operating free-air temperature	<b>–</b> 55		125	0		70	°c	

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS †				SN54LS11			SN74LS11		
PARAMETER				MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	I <sub>I</sub> = - 18 mA				<b>– 1.5</b>			- 1.5	٧
Vон	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 0.4 mA	2.5	3.4		2.7	3.4		V
V	V <sub>CC</sub> = MIN,	VIL = MAX,	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	V
VOL	V <sub>CC</sub> = MIN,	VIL = MAX,	I <sub>OL</sub> = 8 mA					0.35	0.5	V
11	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7 V				0.1			0.1	mA
Чн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				20			20	μΑ
IIL.	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 0.4			- 0.4	mA
IOS §	V <sub>CC</sub> = MAX			- 20		- 100	- 20		- 100	mA
Іссн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			1.8	3.6		1.8	3.6	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0 V			3.3	6.6		3.3	6.6	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
<sup>t</sup> PLH .	A, B or C	_	$R_1 = 2 k\Omega$ ,	C. = 15 pF		8	15	ns
<sup>t</sup> PHL	A, 5 01 C	·	11 - 2 K32,	C <sub>L</sub> = 15 pF		10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## recommended operating conditions

			SN54S11			SN74S11			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			٧	
VIL	Low-level input voltage			0.8			0.8	٧	
ЮН	High-level output current			- 1			<b>– 1</b>	mA	
IOL	Low-level output current			20			20	mA	
TA	Operating free-air temperature	- 55		125	0		70	°c	

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEGT CONDITIONS A				SN54S1	1			UNIT	
PARAMETER		TEST CONDITIONS †			TYP ‡	MAX	MIN	TYP ‡	MAX	CIVIT
VIK	V <sub>CC</sub> = MIN,	I <sub>1</sub> = - 18 mA				- 1.2			- 1.2	٧
Voн	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 1 mA	2.5	3.4		2.7	3.4		٧
VOL	V <sub>CC</sub> = MIN,	V <sub>1L</sub> = 0.8 V,	1 <sub>OL</sub> = 20 mA			0.5			0.5	٧
II	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5 V				1			1	mA
IН	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				50			50	μА
l <sub>IL</sub>	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.5 V				- 2			- 2	mA
IOS §	V <sub>CC</sub> = MAX			-40		- 100	- 40		- 100	mA
ІССН	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			13.5	24		13.5	24	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0 V			24	42		24	42	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
t <sub>PLH</sub>			$R_1 = 280 \Omega$ ,	C <sub>1</sub> = 15 pF		4.5	7	ns
tpHL	A, B or C	v	N 200 12,	CL - 19 PF		5	7.5	ns
t <sub>PLH</sub>	A, B of C	,	D - 200 C	0 - 50 - 5		6		ns
tpHL.			R <sub>L</sub> = 280 Ω,	C <sub>L</sub> = 50 pF		7.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## PACKAGE OPTION ADDENDUM



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## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
JM38510/08001BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
JM38510/08001BDA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
JM38510/31001B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/31001BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
JM38510/31001BDA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SN54LS11J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54S11J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN74LS11D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS11DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS11J	OBSOLETE	CDIP	J	14		None	Call TI	Call TI
SN74LS11N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS11N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74LS11NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S11D	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
SN74S11N	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74S11N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SNJ54LS11FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS11J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54LS11W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SNJ54S11FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S11J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54S11W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens,

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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## **PACKAGE OPTION ADDENDUM**

28-Feb-2005

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